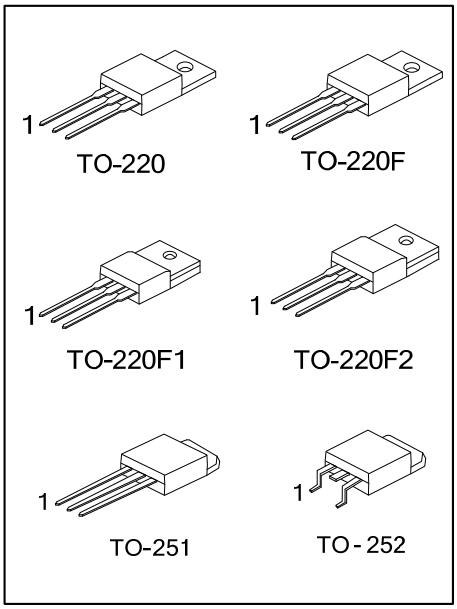
8.0A, 650V N-CHANNEL POWER MOSFET



■ DESCRIPTION

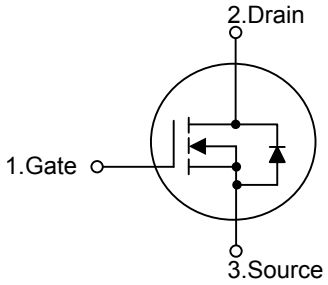
The UTC **8N65-CBQ** is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **8N65-CBQ** is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.

■ FEATURES

* $R_{DS(ON)}$ < 1.3Ω @ V_{GS}=10V, I_D=4.0A
* High Switching Speed
* 100% Avalanche Tested

■ SYMBOL



■ ORDERING INFORMATION

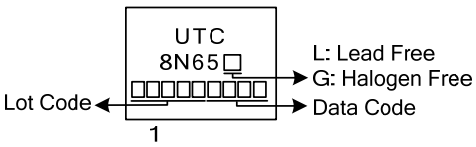
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
8N65L-TA3-T	8N65G-TA3-T	TO-220	G	D	S	Tube
8N65L-TF1-T	8N65G-TF1-T	TO-220F1	G	D	S	Tube
8N65L-TF2-T	8N65G-TF2-T	TO-220F2	G	D	S	Tube
8N65L-TF3-T	8N65G-TF3-T	TO-220F	G	D	S	Tube
8N65L-TM3-T	8N65G-TM3-T	TO-251	G	D	S	Tube
8N65L-TN3-R	8N65G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

8N65L-TA3-T
(1)Packing Type
(2)Package Type
(3)Green Package

(1) T: Tube, R: Tape Reel
(2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TM3: TO-251, TN3: TO-252
(3) L: Lead Free, G: Halogen Free and Lead Free

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	650	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	I_D	8.0	A
	Pulsed (Note 2)	I_{DM}	32	A
Avalanche Current (Note 3)		I_{AR}	2.6	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	34	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.0	V/ns
Power Dissipation	TO-220	P_D	147	W
	TO-220F/TO-220F1		51	W
	TO-220F2		53	W
	TO-251/TO-252		82	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. L = 10mH, I_{AS} = 2.6A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
4. I_{SD} ≤ 8.0A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

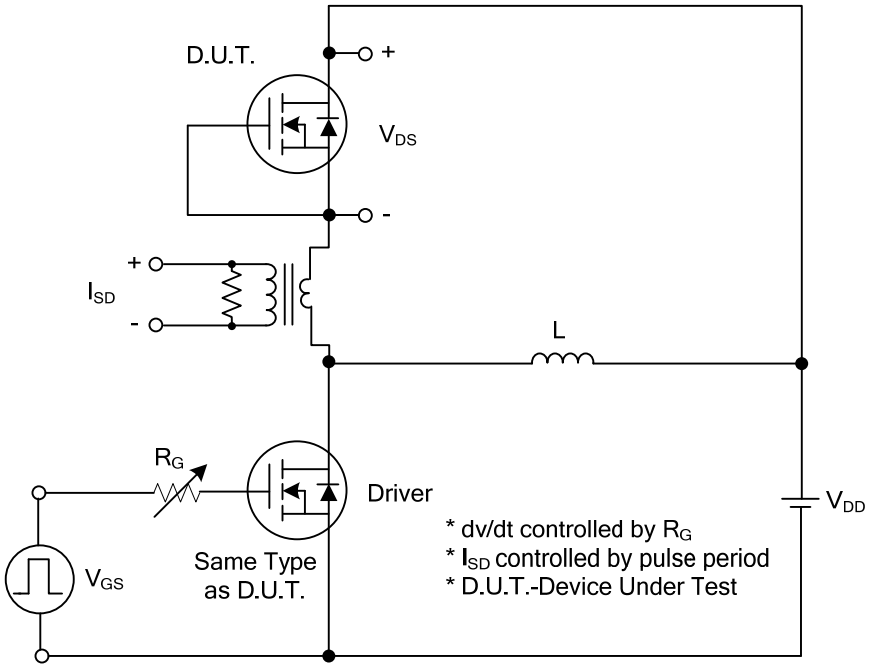
PARAMETER	PACKAGE	SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2	θ_{JA}	62.5	°C/W
	TO-251/TO-252		110	°C/W
Junction to Case	TO-220	θ_{JC}	0.85	°C/W
	TO-220F/TO-220F1		2.45	°C/W
	TO-220F2		2.36	°C/W
	TO-251/TO-252		1.52	°C/W

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

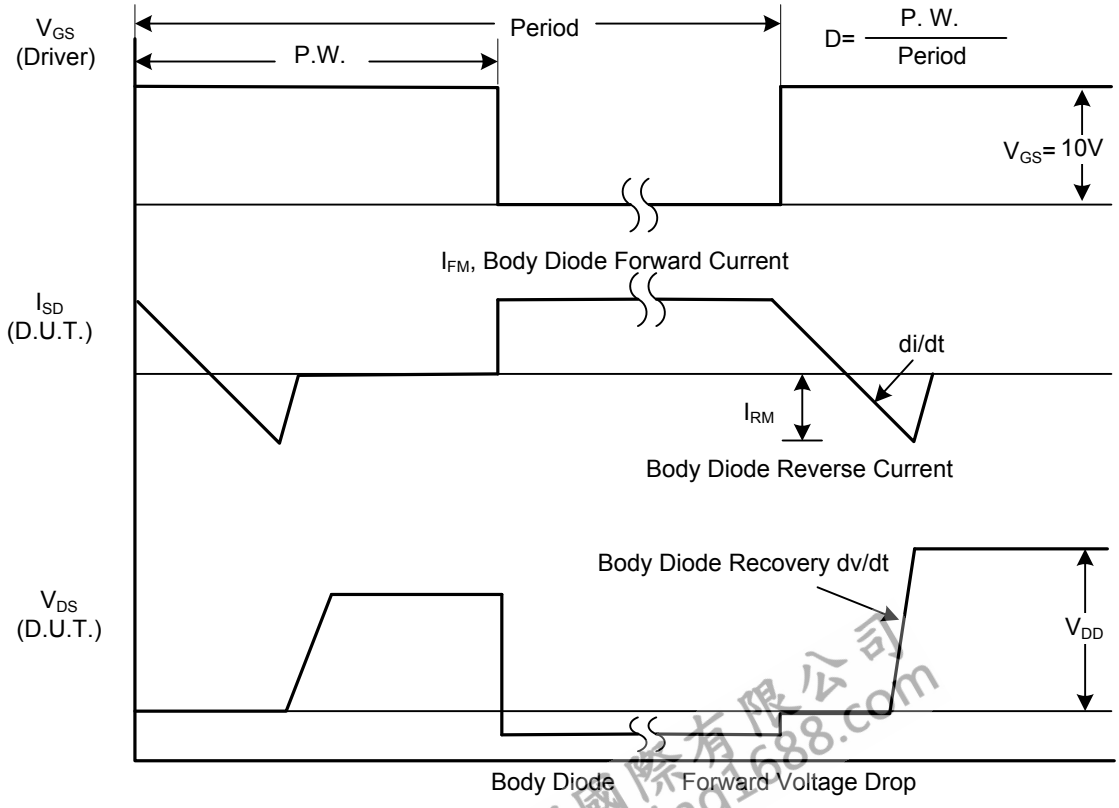
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	I_D=250μA, V_{GS}=0V	650			V
Drain-Source Leakage Current		I_{DSS}	V_{DS}=650V, V_{GS}=0V			1	μA
Gate- Source Leakage Current	Forward	I_{GSS}	V_{GS}=+30V, V_{DS}=0V			+100	nA
	Reverse		V_{GS}=-30V, V_{DS}=0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=10V, I_D=4.0A			1.3	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}	V_{GS}=0V, V_{DS}=25V, f=1.0MHz		1122		pF
Output Capacitance		C_{OSS}			98		pF
Reverse Transfer Capacitance		C_{RSS}			6.0		pF
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		Q_G	V_{DS}=50V, V_{GS}=10V, I_D=1.3A I_G=100μA (Note 1, 2)		70		nC
Gate to Source Charge		Q_{GS}			6.5		nC
Gate to Drain Charge		Q_{GD}			7.0		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	V_{DD}=30V, V_{GS}=10V, I_D =0.5A, R_G =25Ω (Note 1, 2)		52		ns
Rise Time		t_R			27		ns
Turn-OFF Delay Time		$t_{D(OFF)}$			200		ns
Fall-Time		t_F			33		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				8	A
Maximum Body-Diode Pulsed Current (Note 1)		I_{SM}				32	A
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I_S=8.0A, V_{GS}=0V			1.4	V
Body Diode Reverse Recovery Time		t_{rr}	I_S=8.0A, V_{GS}=0V, dI_F/dt=100A/μs		355		ns
Body Diode Reverse Recovery Charge		Q_{rr}			2.37		μC

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

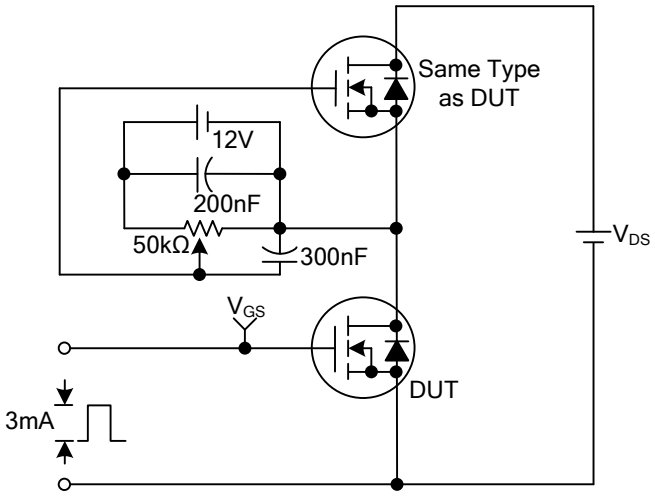


Peak Diode Recovery dv/dt Test Circuit

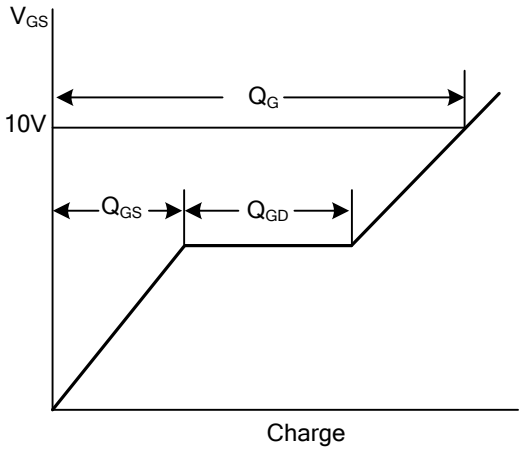


Peak Diode Recovery dv/dt Waveforms

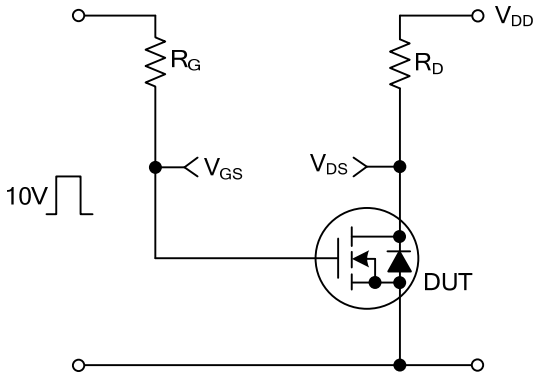
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



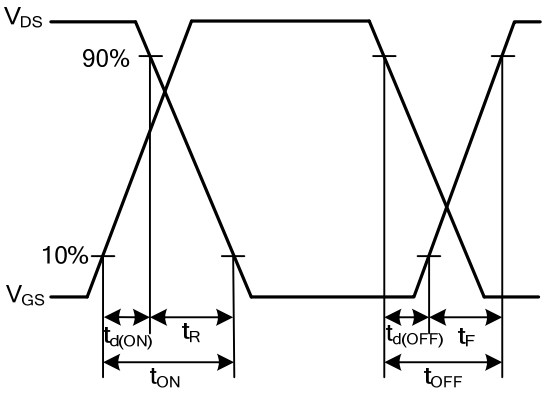
Gate Charge Test Circuit



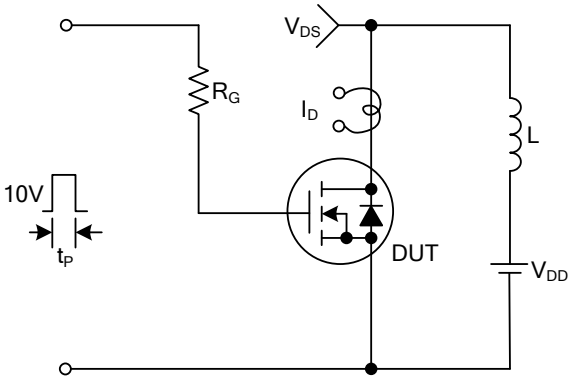
Gate Charge Waveforms



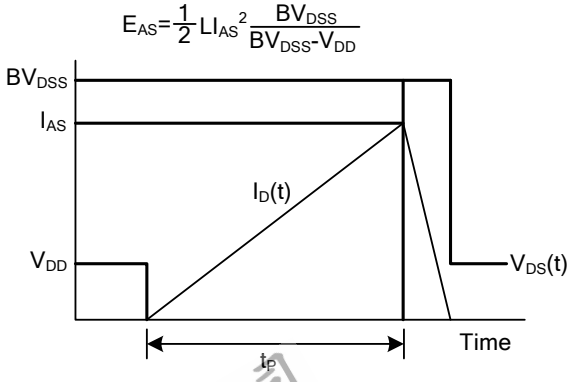
Resistive Switching Test Circuit



Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms